



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





## PNP Silicon VHF-UHF Amplifier Transistors

Qualified per MIL-PRF-19500/426

*Qualified Levels:  
JAN, JANTX,  
and JANTXV*

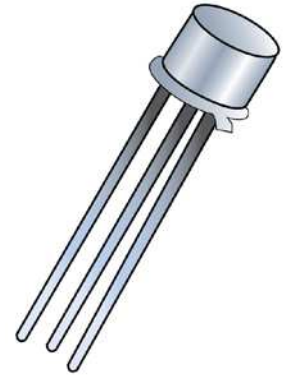
### DESCRIPTION

The 2N4957 is a military qualified silicon PNP amplifier transistor designed for VHF-UHF equipment and other high-reliability applications. Common applications include high gain low noise amplifier; oscillator, and mixer applications. It is also available in a low-profile UB surface mount package.

**Important:** For the latest information, visit our website <http://www.microsemi.com>.


### FEATURES

- JEDEC registered 2N4957
- JAN, JANTX, and JANTXV military qualified versions are available per MIL-PRF-19500/426 (See [part nomenclature](#) for all available options)
- RoHS compliant version available (commercial grade only)



**TO-72 Package**

Also available in:

 **UB Package**  
(surface mount)  
[2N4957UB](#)

### APPLICATIONS / BENEFITS

- Low-power, ultra-high frequency transistor
- Leaded metal TO-72 package

### MAXIMUM RATINGS @ T<sub>A</sub> = +25 °C

Parameters/Test Conditions	Symbol	Value	Unit
Junction and Storage Temperature	T <sub>J</sub> and T <sub>STG</sub>	-65 to +200	°C
Collector-Emitter Voltage	V <sub>CEO</sub>	-30	V
Collector-Base Voltage	V <sub>CBO</sub>	-30	V
Emitter-Base Voltage	V <sub>EBO</sub>	-3	V
Total Power Dissipation <sup>(1)</sup>	P <sub>T</sub>	200	mW
Collector Current	I <sub>C</sub>	-30	mA

**Notes:** 1. Derate linearly 1.14 mW/°C for T<sub>A</sub> > +25 °C

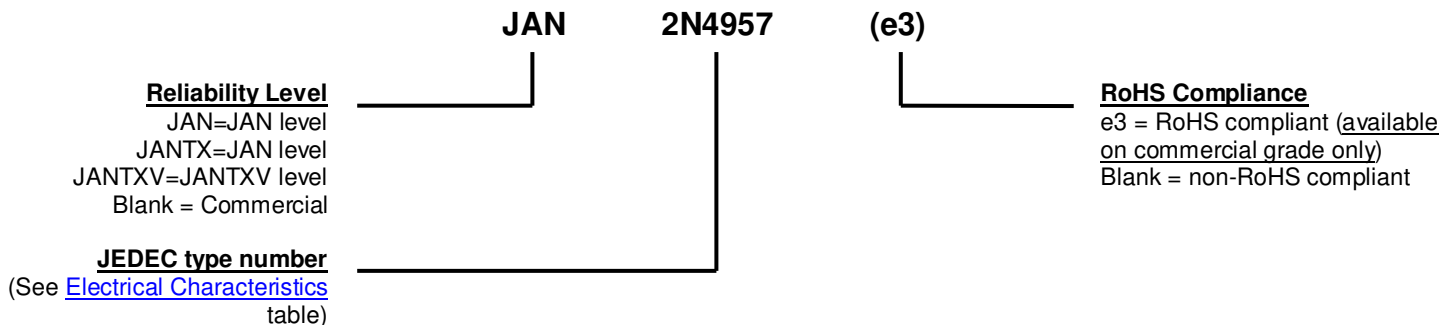
**MSC – Lawrence**  
6 Lake Street,  
Lawrence, MA 01841  
Tel: 1-800-446-1158 or  
(978) 620-2600  
Fax: (978) 689-0803

**MSC – Ireland**  
Gort Road Business Park,  
Ennis, Co. Clare, Ireland  
Tel: +353 (0) 65 6840044  
Fax: +353 (0) 65 6822298

**Website:**  
[www.microsemi.com](http://www.microsemi.com)

**MECHANICAL and PACKAGING**

- CASE: Ni plated kovar, Ni cap
- TERMINALS: Gold over nickel plated kovar leads, solder dipped. RoHS compliant versions are available without solder dip on commercial grade only.
- MARKING: Manufacturer's ID, date code, part number
- POLARITY: PNP, see case outline on last page
- WEIGHT: Approximately 0.322 grams
- See [Package Dimensions](#) on last page.

**PART NOMENCLATURE**

**SYMBOLS & DEFINITIONS**

Symbol	Definition
$I_B$	Base current: The value of the dc current into the base terminal.
$I_C$	Collector current: The value of the dc current into the collector terminal.
$I_E$	Emitter current: The value of the dc current into the emitter terminal.
$T_A$	Ambient temperature: The air temperature measured below a device, in an environment of substantially uniform temperature, cooled only by natural air convection and not materially affected by reflective and radiant surfaces.
$T_C$	Case temperature: The temperature measured at a specified location on the case of a device.
$V_{CB}$	Collector-base voltage: The dc voltage between the collector and the base.
$V_{CBO}$	Collector-base voltage, base open: The voltage between the collector and base terminals when the emitter terminal is open-circuited.
$V_{CEO}$	Collector-emitter voltage, base open: The voltage between the collector and the emitter terminals when the base terminal is open-circuited.
$V_{EB}$	Emitter-base voltage: The dc voltage between the emitter and the base.
$V_{EBO}$	Emitter-base voltage, collector open: The voltage between the emitter and base terminals with the collector terminal open-circuited.

**ELECTRICAL CHARACTERISTICS @  $T_C = +25^\circ\text{C}$** 
**OFF CHARACTERISTICS**

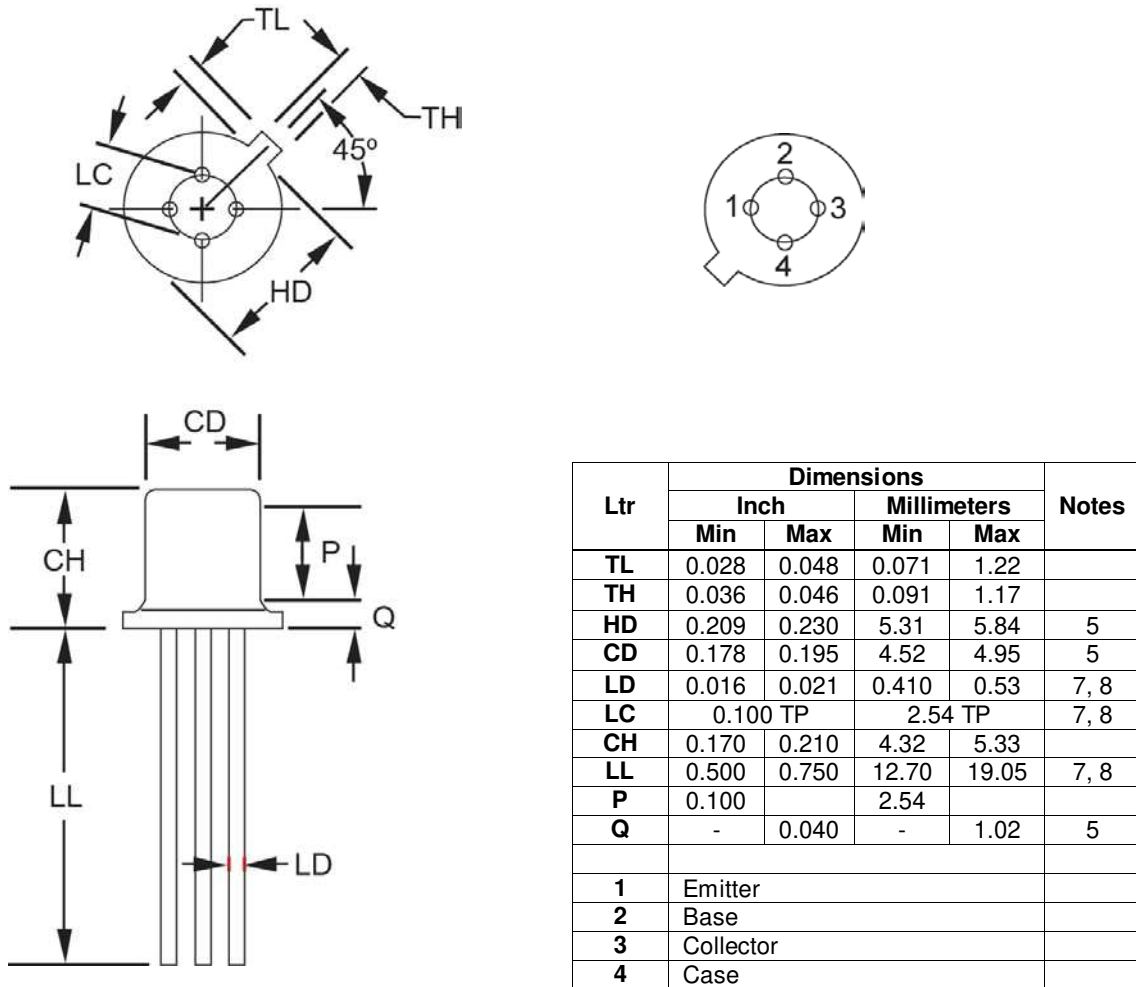
Test Conditions	Symbol	Value		Unit
		Min.	Max.	
Collector-Emitter Breakdown Voltage $I_C = -1.0\text{ mA}$ , $I_B = 0$ , Bias condition D	$V_{(BR)CEO}$	-30	-	V
Collector to Base Cutoff Current $V_{CB} = -20\text{ V}$ , $I_E = 0$ , Bias condition D $V_{CB} = -30\text{ V}$ , Bias condition D	$I_{CBO}$	-	-100 -100	nA $\mu\text{A}$
Emitter to Base Cutoff Current $V_{EB} = -3\text{ V}$ , Bias condition D	$I_{EBO}$	-	-100	$\mu\text{A}$

**ON CHARACTERISTICS**

Test Conditions	Symbol	Value		Unit
		Min.	Max.	
Forward Current transfer ratio $I_C = -0.5\text{ mA}$ , $V_{CE} = -10\text{ V}$ $I_C = -2.0\text{ mA}$ , $V_{CE} = -10\text{ V}$ $I_C = -5.0\text{ mA}$ , $V_{CE} = -10\text{ V}$ $I_C = -5.0\text{ mA}$ , $V_{CE} = -10\text{ V}$ , $T_A = -55^\circ\text{C}$	$h_{FE}$	15 20 30 10	165	

**DYNAMIC CHARACTERISTICS**

Test Conditions	Symbol	Value		Unit
		Min.	Max.	
Magnitude of common emitter small signal short circuit forward current transfer ratio $V_{CE} = -10\text{ V}$ , $I_E = -2.0\text{ mA}$ , $f = 100\text{ MHz}$	$ h_{fe} $	12	36	
Collector-base time constant $I_E = -2.0\text{ mA}$ , $V_{CB} = -10.0\text{ V}$ , $f = 63.6\text{ MHz}$	$r_b'C_c$	1.0	8.0	ps
Collector to Base – feedback capacitance $I_E = 0\text{ mA}$ , $V_{CB} = -10\text{ V}$ , $100\text{ kHz} \leq f \leq 1\text{ MHz}$	$C_{cb}$		0.8	pF
Noise Figure (50 Ohms) $I_C = -2.0\text{ mA}$ , $V_{CE} = -10\text{ V}$ , $f = 450\text{ MHz}$ , $R_L = 50\ \Omega$	NF		3.5	dB
Small Signal Power Gain (common emitter) $I_C = -2.0\text{ mA}$ , $V_{CE} = -10\text{ V}$ , $f = 450\text{ MHz}$	$G_{pe}$	17	25	dB

**PACKAGE DIMENSIONS**

**NOTES:**

- Dimensions are in inches.
- Millimeters are given for information only.
- Beyond r (radius) maximum, TH shall be held for a minimum length of 0.011 (0.28 mm).
- Dimension TL measured from maximum HD.
- Body contour optional within zone defined by HD, CD, and Q.
- Leads at gauge plane 0.054 +0.001 -0.000 inch (1.37 +0.03 -0.00 mm) below seating plane shall be within 0.007 inch (0.18mm) radius of true position (TP) at maximum material condition (MMC) relative to tab at MMC. The device may be measured by direct methods.
- Dimension LU applies between L1 and L2. Dimension LD applies between L2 and LL minimum. Diameter is uncontrolled in L1 and beyond LL minimum.
- All four leads.
- Dimension r (radius) applies to both inside corners of tab.
- In accordance with ASME Y14.5M, diameters are equivalent to  $\Phi$ x symbology.
- Lead 1 = emitter, lead 2 = base, lead 3 = collector, lead 4 = case (electrically connected).